

80V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _C = +25°C
80V	26mΩ @ V _{GS} = 10V	28.5A
	45mΩ @ V _{GS} = 4.5V	21A

Description and Applications

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

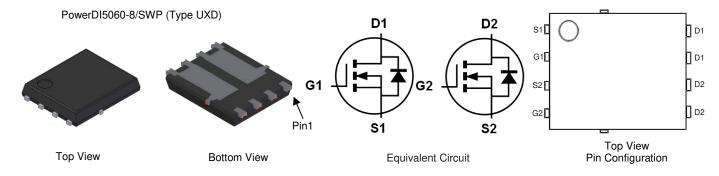
- DC-DC converters
- Motors

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Additional Tin-Plated on Sidewall Pads for Optical Solder Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMTH8030LPDWQ)

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	Dookaga	Packing		
Part Number	Package	Qty.	Carrier	
DMTH8030LPDW-13	PowerDI5060-8/SWP (Type UXD)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

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Marking Information



⊃¦¦ = Manufacturer's MarkingH8030LPDW = Product Type Marking CodeYYWW = Date Code Marking YY = Year (ex: 22 = 2022) WW = Week (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	80	V
Gate-Source Voltage	Vgss	±20	V
Continuous Drain Current, VGS = 10V (Note 6)	lo	28.5 20	А
Maximum Body Diode Forward Current	Is	29	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	113.5	Α
Pulsed Body Diode Forward Current (10μs Pulse, Tc = +25°C, Packa	Isм	113.5	Α
Avalanche Current, L = 0.3mH	las	12.5	Α
Avalanche Energy, L = 0.3mH	Eas	23.4	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Ambient (Note 5)		Reja	48	°C/W
Total Power Dissipation $T_A = +25^{\circ}C$		PD	3.1	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	3.7	°C/W
Total Power Dissipation $T_C = +25^{\circ}C$		P _D	41	W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes:

^{5.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 6. Thermal resistance from junction to solder point (on the exposed drain pin).



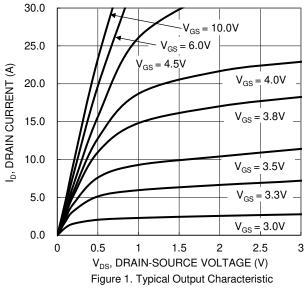
Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	80	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	-	_	1	μΑ	$V_{DS} = 64V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.3	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	20	26	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	29	45	11177	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V _{SD}	_	0.9	1.2	V	V _G S = 0V, I _S = 10A	
DYNAMIC CHARACTERISTICS (Note 8)				•	•		
Input Capacitance	Ciss	-	631	_		V _{DS} = 40V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	200	_	pF		
Reverse Transfer Capacitance	Crss	_	19.5	_			
Gate Resistance	Rg	_	1.1	_	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.4	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	10.4	_	nC	V 40V I 7.54	
Gate-Source Charge	Qgs	_	1.8	_	IIC	$V_{DS} = 40V, I_{D} = 7.5A$	
Gate-Drain Charge	Qgd		2.4	_			
Turn-On Delay Time	t _{D(ON)}		7.1	_			
Turn-On Rise Time	tr		9.7	_		$V_{DD} = 40V$, $V_{GS} = 4.5V$, $R_G = 2.7\Omega$, $I_D = 10A$	
Turn-Off Delay Time	tD(OFF)		18.6	_	ns		
Turn-Off Fall Time	tF		8.6	_			
Body Diode Reverse Recovery Time	t _{RR}		28.5	_	ns	I _F = 7.5A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Qrr	_	21.7	_	nC	I _F = 7.5A, di/dt = 100A/μs	

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





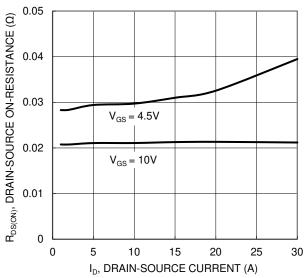


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

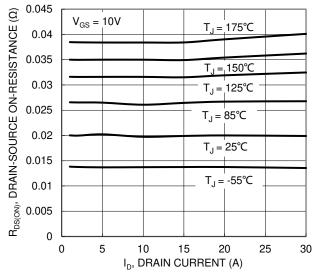
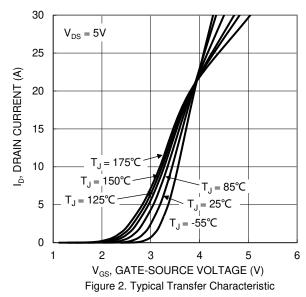
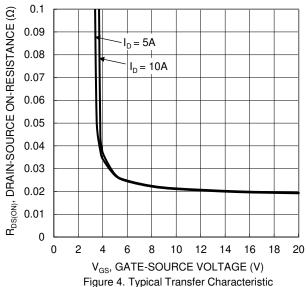


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





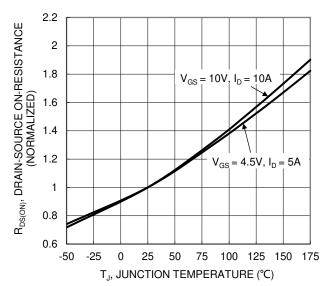


Figure 6. On-Resistance Variation with Junction Temperature



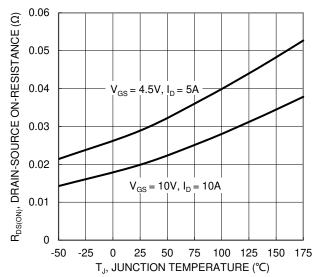
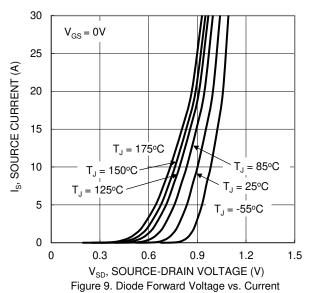
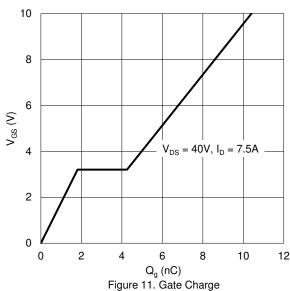


Figure 7. On-Resistance Variation with Junction Temperature





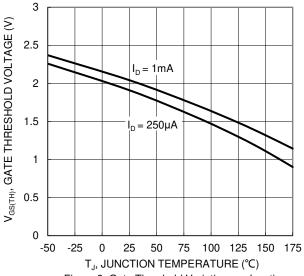
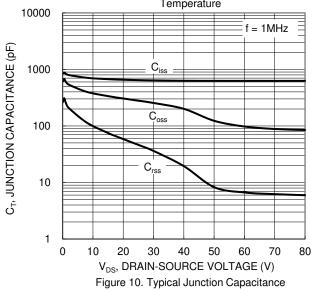


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R_{DS(ON)} Limited 100 ID, DRAIN CURRENT (A) 10 $P_W = 100 \mu s$ $T_{J(Max)} = 175$ °C T_C = 25°C Single Pulse DUT on Infinite Heatsink $V_{GS} = 10V$ 0.01 0.1 10 100 V_{DS} , DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



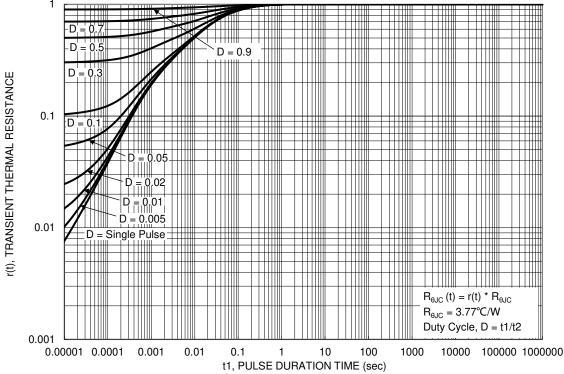


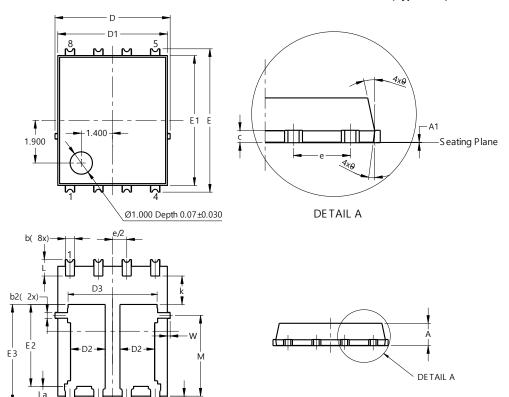
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



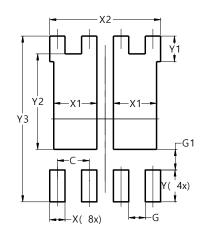
PowerDI5060-8/SWP (Type UXD)							
Dim	Min	Max	Тур				
Α	0.90	1.10	1.00				
A1	0.00	0.05					
b	0.30	0.50	0.41				
b2	0.20	0.35	0.25				
b4).25REF					
С	0.230	0.330	0.277				
D	5	5.15 BSC					
D1	4.70	5.10	4.90				
D2	1.46	1.66	1.55				
D3	3.78	4.18	3.98				
Е	6	.40 BS0)				
E1	5.60	6.00	5.80				
E2	3.46 3.86		3.66				
E2a	4.195	4.595	4.395				
е		.27BSC)				
k	1.05						
L	0.635	0.835	0.735				
La	0.635	0.835	0.735				
L1	0.200	0.400	0.300				
M	3.205	4.005	3.605 0.125				
W	0.025	0.025 0.225					
θ	10°	12°	11°				
θ1	6°	8°	7°				
All	All Dimensions in mm						

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

-b4(8x)

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value			
פווטופווסוטווס	(in mm)			
C	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	1.720			
X2	4.420			
Υ	1.270			
Y1	1.020			
Y2	3.810			
Y3	6.610			



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